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Team Nexperia

CBT3257A

Quad 1-of-2 multiplexer/demultiplexer Rev. 5 — 4 April 2013

Product data sheet

General description 1.

The CBT3257A is a quad 1-of-2 high-speed TTL-compatible multiplexer/demultiplexer. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise.

Output enable (OE) and select-control (S) inputs select the appropriate nB1 and nB2 outputs for the nA input data.

The CBT3257A is characterized for operation from -40 °C to +85 °C.

Features and benefits 2.

- \blacksquare 5 Ω switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- Latch-up protection exceeds 100 mA per JEDEC standard JESD78 class II level A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from -40 °C to +85 °C



Quad 1-of-2 multiplexer/demultiplexer

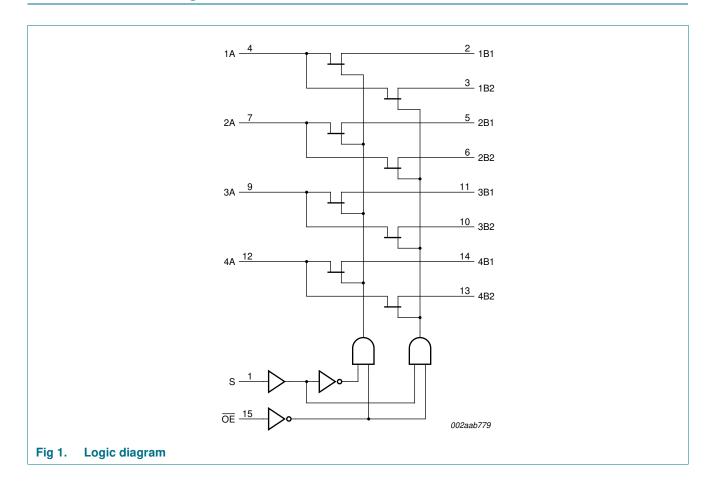
3. Ordering information

Table 1. Ordering information

| Type number | Temperature range | Package | Package | | | | | | | | | |
|-------------|-------------------|-----------|--|----------|--|--|--|--|--|--|--|--|
| | | Name | Description | Version | | | | | | | | |
| CBT3257AD | –40 °C to +85 °C | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 | | | | | | | | |
| CBT3257ADB | –40 °C to +85 °C | SSOP16 | plastic shrink small outline package; 16 leads; body width 5.3 mm | SOT338-1 | | | | | | | | |
| CBT3257ADS | –40 °C to +85 °C | SSOP16[1] | plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm | SOT519-1 | | | | | | | | |
| CBT3257APW | –40 °C to +85 °C | TSSOP16 | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 | | | | | | | | |
| CBT3257ABQ | –40 °C to +85 °C | DHVQFN16 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5\times3.5\times0.85$ mm | SOT763-1 | | | | | | | | |

^[1] Also known as QSOP16.

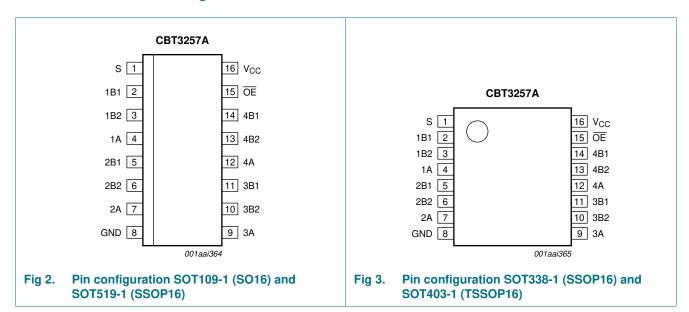
4. Functional diagram

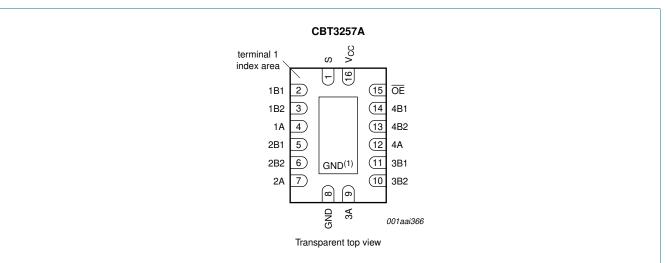


Quad 1-of-2 multiplexer/demultiplexer

5. Pinning information

5.1 Pinning





(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

Fig 4. Pin configuration SOT763-1 (DHVQFN16)

Quad 1-of-2 multiplexer/demultiplexer

5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|---------------------|--------------|----------------------------|
| S | 1 | select control input |
| 1B1, 2B1, 3B1, 4B1, | 2, 5, 11, 14 | B1 outputs/inputs |
| 1B2, 2B2, 3B2, 4B2 | 3, 6, 10, 13 | B2 outputs/inputs |
| 1A, 2A, 3A, 4A | 4, 7, 9, 12 | A inputs/outputs |
| GND | 8 | ground (0 V) |
| ŌĒ | 15 | output enable (active LOW) |
| V _{CC} | 16 | positive supply voltage |

6. Functional description

Table 3. Function selection

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = Don't \ care.$

| Inputs OE | | Switch |
|--------------|---|------------|
| OE | S | |
| L | L | nA to nB1 |
| L | Н | nA to nB2 |
| Н | Χ | switch off |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|-------------------------|---|-----------------|------|------|
| V_{CC} | supply voltage | | -0.5 | +7.0 | V |
| VI | input voltage | | <u>[1]</u> –0.5 | +7.0 | V |
| I_{SW} | switch current | continuous current through each switch | - | 128 | mA |
| I_{IK} | input clamping current | $V_1 < 0 V$ | -50 | _ | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$ | | | |
| | | SO16 package | [2] - | 500 | mW |
| | | SSOP16 package | [3] _ | 500 | mW |
| | | TSSOP16 package | [3] _ | 500 | mW |
| | | DHVQFN16 package | <u>[4]</u> _ | 500 | mW |

^[1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

^[2] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 $^{\circ}\text{C}.$

^[3] For SSOP16 and TSSOP16 package: P_{tot} derates linearly with 5.5 mW/K above 70 °C.

^[4] For DHVQFN16 package: Ptot derates linearly with 4.5 mW/K above 70 °C.

Quad 1-of-2 multiplexer/demultiplexer

8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|--------------------------|-----------------------|-----|-----|------|
| V_{CC} | supply voltage | | 4.5 | 5.5 | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | V |
| V _{IL} | LOW-level input voltage | | - | 8.0 | V |
| T _{amb} | ambient temperature | operating in free-air | -40 | +85 | °C |

9. Static characteristics

Table 6. Static characteristics

 $T_{amb} = -40 \, ^{\circ}\!\text{C} \text{ to } +85 \, ^{\circ}\!\text{C}.$

| Min | Typ[1] | Max | Unit |
|--------------------------|--------|------|-----------------------------------|
| | | | Oint |
| - | - | -1.2 | V |
| 3.6 | 3.9 | 4.2 | V |
| - | - | ±1 | μΑ |
| - | - | 3 | μΑ |
| at ^[2] -) | - | 2.5 | mA |
| - | 3.3 | - | pF |
| с - | 9.9 | - | pF |
| с - | 6.4 | - | pF |
| [3] | | | |
| - | 5 | 7 | Ω |
| - | 5 | 7 | Ω |
| - | 10 | 15 | Ω |
| | | | ±1 - 3 at [2] 2.5 - 3.3 9.9 6.4 |

^[1] All typical values are measured at V_{CC} = 5 V; T_{amb} = 25 °C.

^[2] This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

^[3] Measured by the voltage drop between the nA and the nBn terminals at the indicated current through the switch. The lowest voltage of the two (nA or nBn) terminals determines the ON resistance.

Quad 1-of-2 multiplexer/demultiplexer

10. Dynamic characteristics

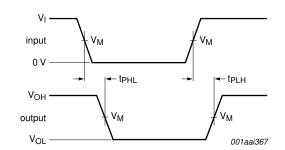
Table 7. Dynamic characteristics

 $T_{amb} = -40$ °C to +85 °C; $V_{CC} = 4.5$ V to 5.5 V; for test circuit see <u>Figure 7</u>.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------|--------------------------------------|----------------|------|------|
| t _{pd} | propagation delay | nA to nBn or nBn to nA; see Figure 5 | [1][2] _ | 0.25 | ns |
| | | S to nA; see Figure 5 | [1][2] 1.4 | 5.0 | ns |
| t _{en} | enable time | OE to nA or nBn; see Figure 6 | <u>[2]</u> 1.5 | 5.1 | ns |
| | | S to nBn; see Figure 6 | <u>12</u> 1.4 | 5.2 | ns |
| t _{dis} | disable time | OE to nA or nBn; see Figure 6 | 2.2 | 5.5 | ns |
| | | S to nBn; see Figure 6 | <u>[2]</u> 1.0 | 5.0 | ns |

^[1] This parameter is warranted but not production tested. The propagation delay is based on the RC time constant of the typical ON resistance of the switch and a load capacitance, when driven by an ideal voltage source (zero output impedance).

11. AC waveforms



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 5. The input (nA; nBn) to output (nBn; nA) or input (S) to output (nA) propagation delay times

^[2] t_{PLH} and t_{PHL} are the same as t_{pd} . t_{PZL} and t_{PZH} are the same as t_{en} . t_{PLZ} and t_{PHZ} are the same as t_{dis} .

Quad 1-of-2 multiplexer/demultiplexer

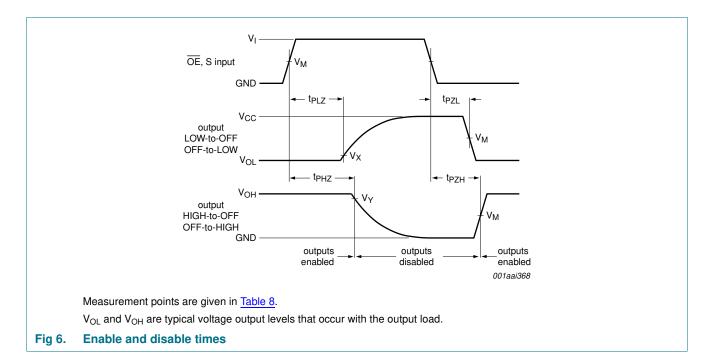
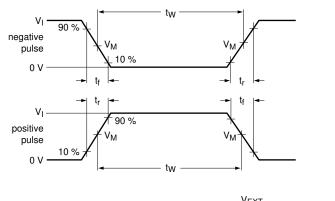


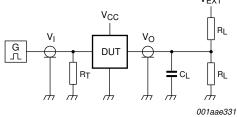
Table 8. Measurement points

| Supply voltage | Input | | Output | | | | | | |
|-----------------|----------------|----------------|----------------|------------------|-----------------|--|--|--|--|
| V _{CC} | V _I | V _M | V _M | V _X | V _Y | | | | |
| 4.5 V to 5.5 V | GND to 3.0 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 V$ | $V_{OH}-0.3\ V$ | | | | |

Quad 1-of-2 multiplexer/demultiplexer

12. Test information





Test data is given in Table 9.

Definitions for test circuit:

R_I = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_0 of the pulse generator.

 V_{EXT} = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

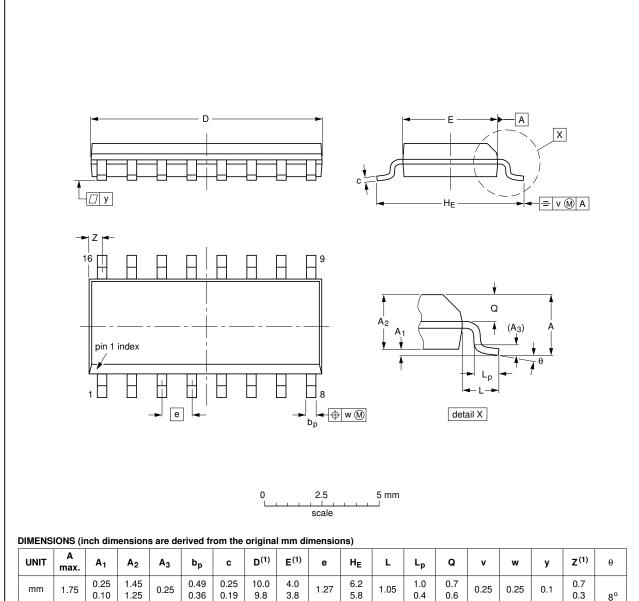
Table 9. Test data

| Supply voltage | Input | | Load | | V _{EXT} | | | | | |
|-----------------|------------------------|---------------|-------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|--|--|--|
| V _{CC} | V_{l} t_{r}, t_{f} | | CL | R _L | t _{PLH} , t _{PHL} | t _{PLZ} , t _{PZL} | t _{PHZ} , t _{PZH} | | | |
| 4.5 V to 5.5 V | GND to 3.0 V | \leq 2.5 ns | 50 pF | 500 Ω | open | 7.0 V | open | | | |

13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|--------|-----------|----------------|----------------|-----------------------|--------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 10.0 9.8 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° |
| inches | 0.069 | 0.010 0.004 | 0.057 0.049 | 0.01 | l | 0.0100 0.0075 | 0.39 0.38 | 0.16 0.15 | 0.05 | 0.244 0.228 | 0.041 | 0.039 0.016 | 0.028 0.020 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | 0° |

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

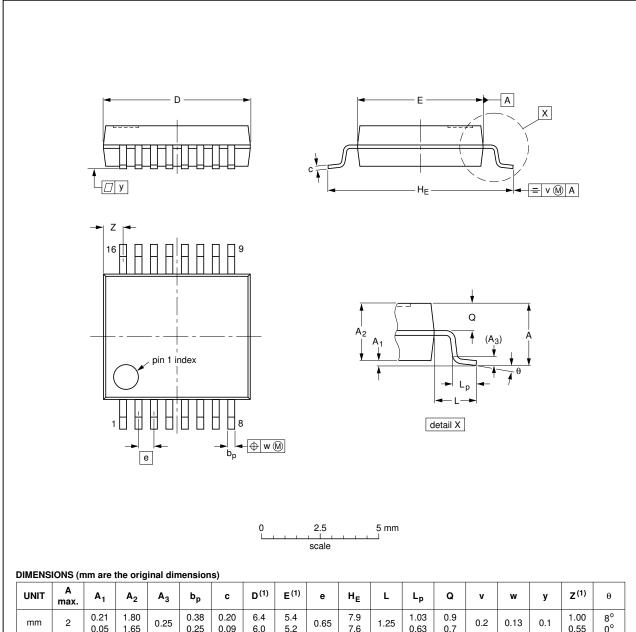
| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | |
|----------|--------|--------|----------|------------|------------|---------------------------------|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE |
| SOT109-1 | 076E07 | MS-012 | | | | 99-12-27 03-02-19 |

Fig 8. Package outline SOT109-1 (SO16)

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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | С | D ⁽¹⁾ | E ⁽¹⁾ | e | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm | 2 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.00 0.55 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

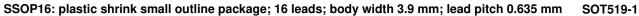
| OUTLINE | | REFER | ENCES | EUROPEAN | ISSUE DATE | |
|----------|-----|-------------|-------|------------|---------------------------------|--|
| VERSION | IEC | IEC JEDEC J | | PROJECTION | ISSUE DATE | |
| SOT338-1 | | MO-150 | | | 99-12-27 03-02-19 | |

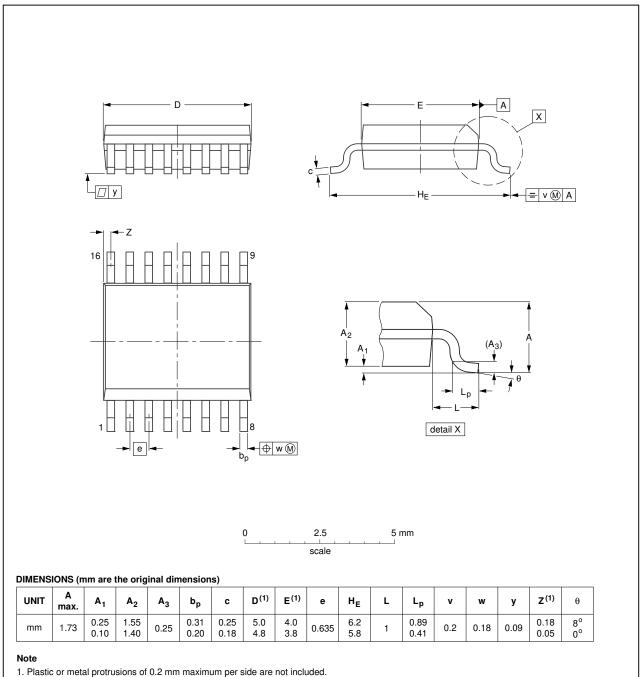
Package outline SOT338-1 (SSOP16) Fig 9.

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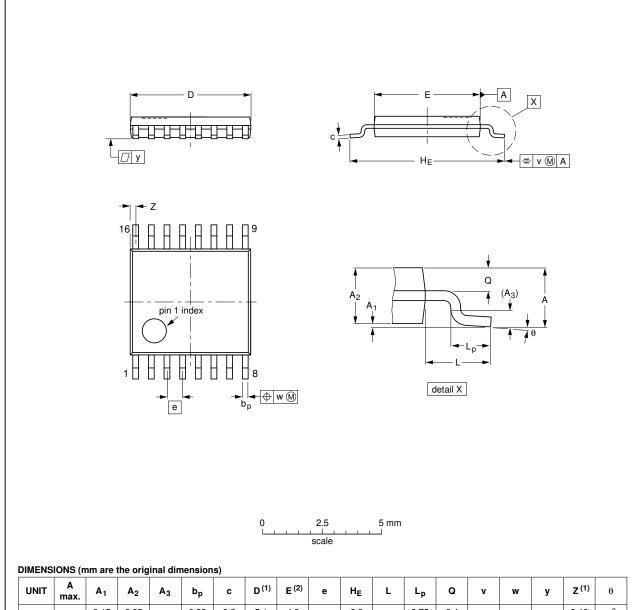
| VERSION IEC JEDEC JEITA PROJECTION SOT519-1 | SSUE DATE | EUROPEAN | | OUTLINE | | | | |
|---|---------------------------------|------------|--|---------|-------|-----|----------|--|
| SO1519-1 + | SSUE DATE | PROJECTION | | JEITA | JEDEC | IEC | VERSION | |
| 03-0 | 99-05-04 03-02-18 | | | | | | SOT519-1 | |

Fig 10. Package outline SOT519-1 (SSOP16)

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E (2) | е | HE | L | Lp | Q | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm | 1.1 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.40 0.06 | 8° 0° |

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| | | EUROPEAN | ISSUE DATE | | | |
|-----|--------|----------|------------|------------|---------------------------------|--|
| IEC | JEDEC | JEITA | | PROJECTION | ISSUE DATE | |
| | MO-153 | | | | 99-12-27 03-02-18 | |
| _ | IEC | | | | IEC JEDEC JEHA | |

Fig 11. Package outline SOT403-1 (TSSOP16)

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Quad 1-of-2 multiplexer/demultiplexer

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

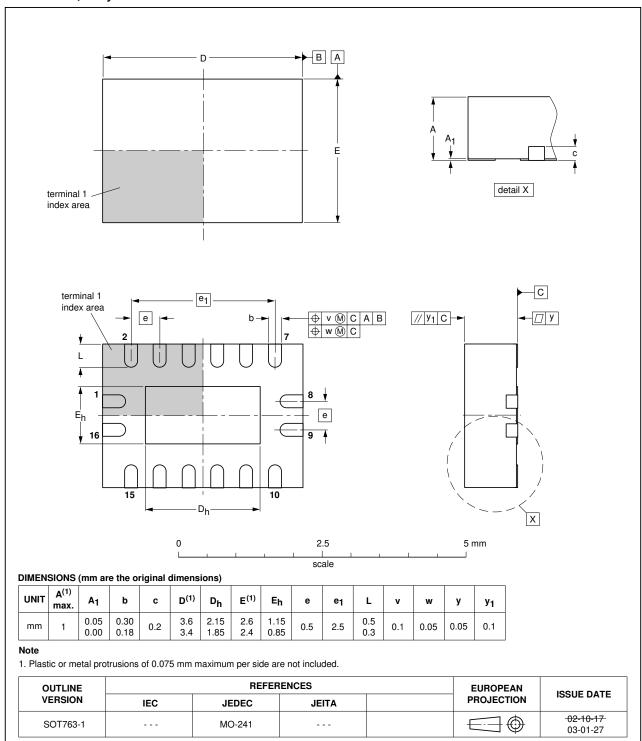


Fig 12. Package outline SOT763-1 (DHVQFN16)

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Quad 1-of-2 multiplexer/demultiplexer

14. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|-----------------------------|
| CDM | Charged Device Model |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

15. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|------------------|---------------------------------|----------------------|--------------|
| CBT3257A v.5 | 20130404 | Product data sheet | - | CBT3257A v.4 |
| Modifications: | Table 6 "Station | characteristics": values for pa | ss voltage modified. | |
| CBT3257A v.4 | 20090319 | Product data sheet | - | CBT3257A v.3 |
| CBT3257A v.3 | 20080704 | Product data sheet | - | CBT3257A v.2 |
| CBT3257A v.2 | 20070704 | Product data sheet | - | CBT3257A v.1 |
| CBT3257A v.1 | 20051027 | Product data sheet | - | - |

Quad 1-of-2 multiplexer/demultiplexer

16. Legal information

16.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|--------------------------------|-------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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Quad 1-of-2 multiplexer/demultiplexer

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